

SURFACE MOUNT
FAST RECOVERY SILICON RECTIFIER
VOLTAGE RANGE 50 to 1000 Volts CURRENT 1.0 Amperes

FEATURES

- * Ideal for surface mounted applications
- * Low leakage current
- * Metallurgically bonded construction
- * Mounting position: Any

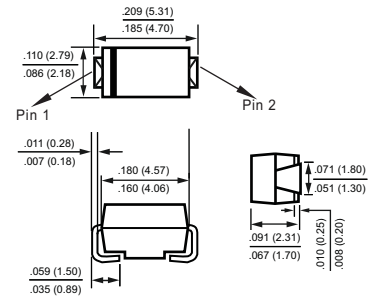
MECHANICAL DATA

- * Epoxy : Device has UL flammability classification 94V-0

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified.
Single phase, half wave, 60 Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

SMX



Dimensions in inches and (millimeters)

MAXIMUM RATINGS (@ TA=25 °C unless otherwise noted)

RATINGS	SYMBOL	FFM101W	FFM102W	FFM103W	FFM104W	FFM105W	FFM106W	FFM107W	UNITS
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at T _A = 55°C	I _O	1.0							Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I _{FSM}	30							Amps
Typical Current Squared Time	i ² T	3.74							A ² S
Typical Thermal Resistance (Note 4)	R _{θJA}	70							°C/W
	R _{θJL}	30							
Typical Junction Capacitance (Note 2)	C _J	15							pF
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to + 150							°C

ELECTRICAL CHARACTERISTICS (@TA=25 °C unless otherwise noted)

CHARACTERISTICS	SYMBOL	FFM101W	FFM102W	FFM103W	FFM104W	FFM105W	FFM106W	FFM107W	UNITS
Maximum Instantaneous Forward Voltage at 1.0ADC	V _F	1.3							Volts
Maximum Fully Load Reverse Current, Fully cycle Average at T _A = 25°C	I _R	50							uAmps
Maximum DC Reverse Current at Rated DC Blocking Voltage @T _A = 25°C		5.0							mAmps
Maximum DC Reverse Current at Rated DC Blocking Voltage @T _A = 150°C		2.0							mAmps
Maximum Reverse Recovery Time (Note 1)	t _{rr}	150				250	500		nSec

NOTES : 1. Reverse Recovery Test Conditions: I_F = 0.5A, I_R = -1.0A, I_{RR} = -0.25A
2. Measured at 1 MHz and applied reverse voltage of 4.0 volts
3. "ROHS compliant".
4. Thermal Resistance : Mounted on PCB.

2020-03/02
REV:D

RATING AND CHARACTERISTICS CURVES (FFM101W THRU FFM107W)

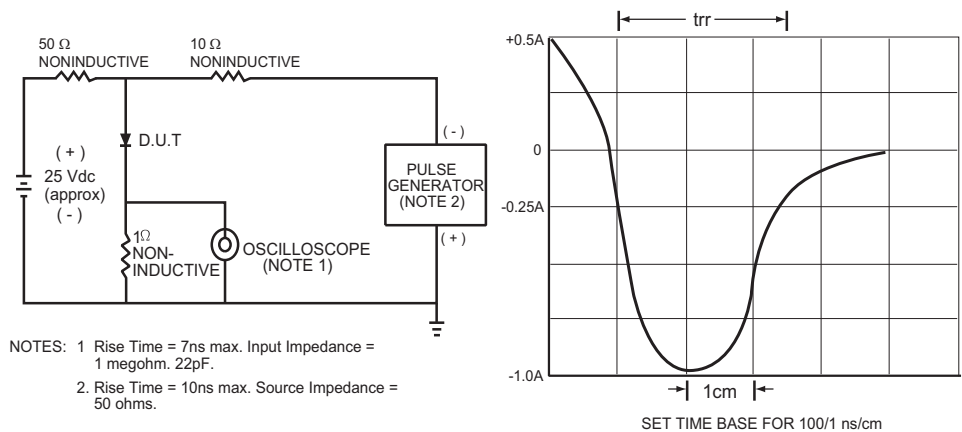


FIG.1 TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC

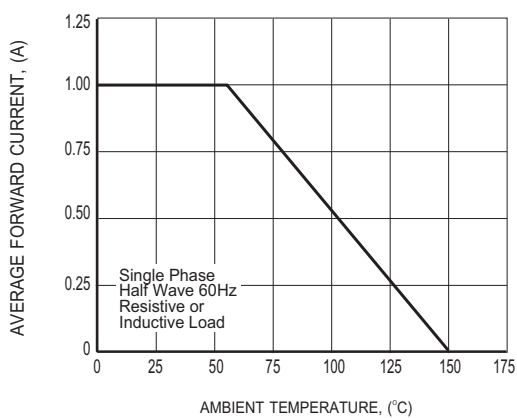


FIG.2 TYPICAL FORWARD CURRENT DERATING CURVE

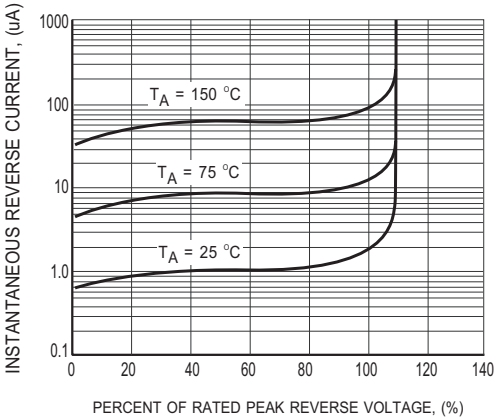


FIG.3 MAXIMUM REVERSE CHARACTERISTICS

RATING AND CHARACTERISTICS CURVES (FFM101W THRU FFM107W)

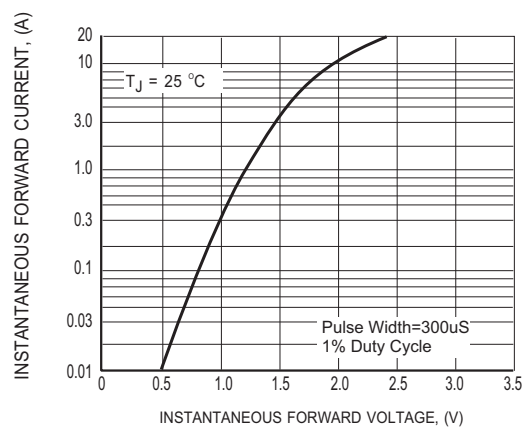


FIG.4 MAXIMUM INSTANTANEOUS FORWARD CHARACTERISTICS

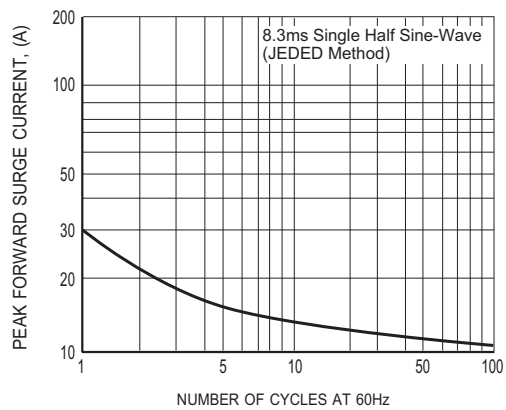


FIG.5 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

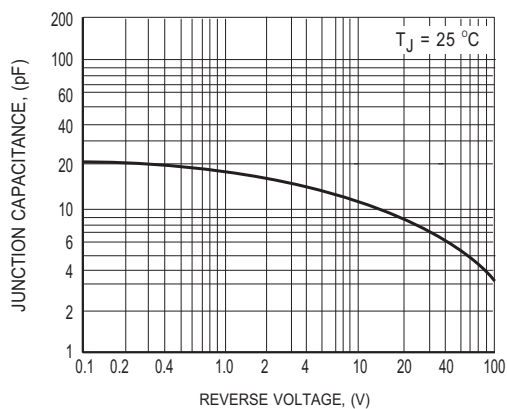
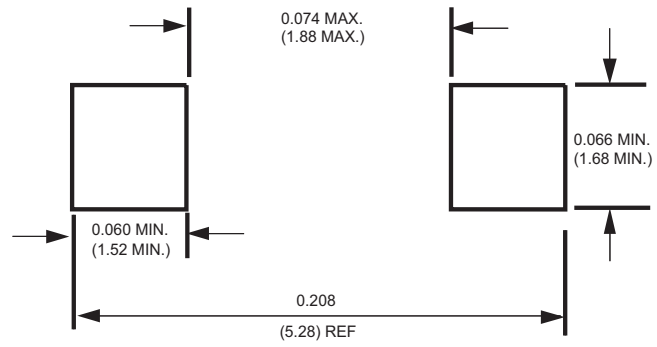


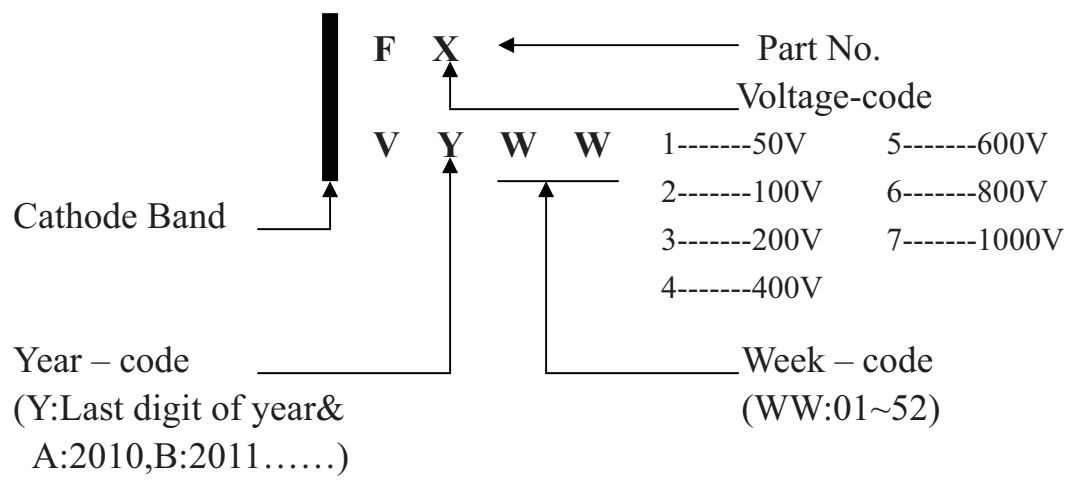
FIG.6 TYPICAL JUNCTION CAPACITANCE

Mounting Pad Layout



Dimensions in inches and (millimeters)

Marking Description



REEL TAPING SPECIFICATIONS FOR SURFACE MOUNT DEVICES-FLAT MELF (SMA/SMB/SMC/SMX)

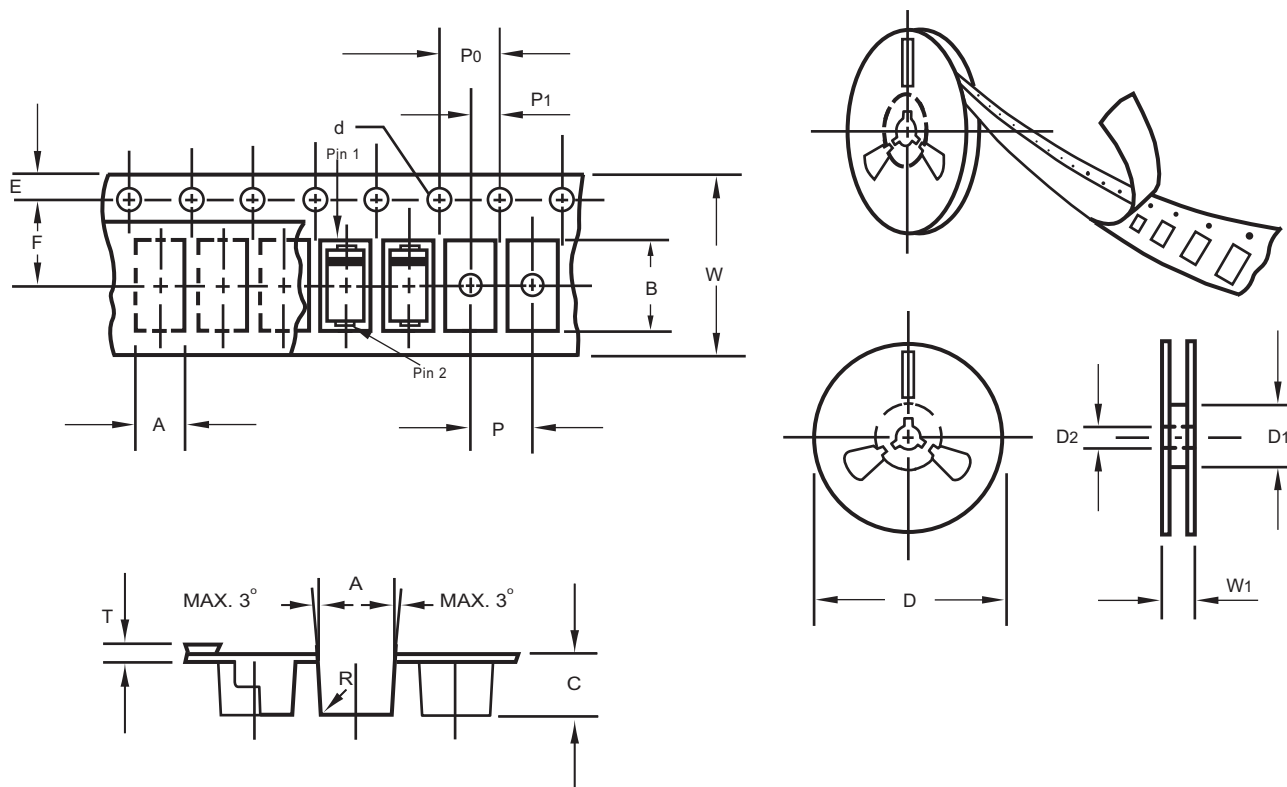


Fig.: Configuration of FLAT MELF TAPING
(SMA/SMB/SMC/SMX)

ITEM	SYMBOL	DO214AC (SMA) mm(inch)	DO214AA (SMB) mm(inch)	DO214AB (SMC) mm(inch)
Carrier width	A	2.6 ± 0.15 (0.102 ± 0.006)	3.65 ± 0.1 (0.144 ± 0.004)	6.0 ± 0.1 (0.236 ± 0.004)
Carrier length	B	5.15 ± 0.15 (0.203 ± 0.006)	5.69 ± 0.1 (0.224 ± 0.004)	8.30 ± 0.1 (0.327 ± 0.004)
Carrier depth	C	2.3 ± 0.15 (0.091 ± 0.006)	2.67 ± 0.1 (0.105 ± 0.004)	2.5 ± 0.1 (0.098 ± 0.004)
Sprocket hole	d	1.5 ± 0.1 (0.059 ± 0.004)	1.5 ± 0.1 (0.059 ± 0.004)	1.5 ± 0.1 (0.059 ± 0.004)
Reel outside diameter	D	178 ± 2.0 (7.0 ± 0.079)	178 ± 2.0 (7.0 ± 0.079)	178 ± 2.0 (7.0 ± 0.079)
Reel inner diameter	D1	50 Min.	50 Min.	50 Min.
Feed hole diameter	D2	13 ± 0.5 (0.512 ± 0.020)	13 ± 0.5 (0.512 ± 0.020)	13 ± 0.5 (0.512 ± 0.020)
Strocket hole position	E	1.75 ± 0.1 (0.059 ± 0.004)	1.75 ± 0.1 (0.059 ± 0.004)	1.75 ± 0.1 (0.059 ± 0.004)
Punch hole position	F	5.65 ± 0.05 (0.222 ± 0.002)	5.65 ± 0.05 (0.222 ± 0.002)	7.5 ± 0.05 (0.301 ± 0.002)
Punch hole pitch	P	4.0 ± 0.1 (0.157 ± 0.004)	8.0 ± 0.1 (0.315 ± 0.004)	8.0 ± 0.1 (0.315 ± 0.004)
Sprocket hole pitch	P0	4.0 ± 0.1 (0.157 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)
Embossment center	P1	2.0 ± 0.1 (0.079 ± 0.004)	2.0 ± 0.1 (0.079 ± 0.004)	2.0 ± 0.1 (0.157 ± 0.004)
Totall tape thickness	T	0.30 ± 0.05 (0.012 ± 0.002)	0.6 Max.	0.6 Max.
Tape width	W	12.0 ± 0.2 (0.472 ± 0.008)	12.0 ± 0.2 (0.472 ± 0.008)	16.0 ± 0.2 (0.630 ± 0.008)
Reel width	W1	16.8 ± 2.0 (0.661 ± 0.079)	16.8 ± 2.0 (0.661 ± 0.079)	24.0 ± 2.0 (0.945 ± 0.079)

Note: 1.Devices are packed in accordance with EIA standard RS-481-D and specification given above.

2.Available on 7 inch (1500 ct.) or 13 inch (5000 ct.) diameter reels.

Visit [http:// www.rectron.com](http://www.rectron.com) for complete datasheets

PACKAGING OF DIODE AND BRIDGE RECTIFIERS

REEL PACK

PACKAGE	PACKING CODE	EA PER REEL	EA PER INNER BOX	COMPONENT SPACE (mm)	TAPE SPACE (mm)	REEL DIA (mm)	CARTON SIZE (mm)	EA PER CARTON	GROSS WEIGHT(Kg)
SMX	-W	7,500	15,000	---	---	330	360*355*360	120,000	15.2

PACKAGE	PACKING CODE	EA PER REEL	EA PER INNER BOX	COMPONENT SPACE (mm)	TAPE SPACE (mm)	REEL DIA (mm)	CARTON SIZE (mm)	EA PER CARTON	GROSS WEIGHT(Kg)
SMX	-T	2,000	8,000	---	---	178	390*205*310	64,000	7.8

DISCLAIMER NOTICE

Rectron Inc reserves the right to make changes without notice to any product specification herein, to make corrections, modifications, enhancements or other changes. Rectron Inc or anyone on its behalf assumes no responsibility or liability for any errors or inaccuracies. Data sheet specifications and its information contained are intended to provide a product description only. "Typical" parameters which may be included on RECTRON data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. Rectron Inc does not assume any liability arising out of the application or use of any product or circuit.

Rectron products are not designed, intended or authorized for use in medical, life-saving implant or other applications intended for life-sustaining or other related applications where a failure or malfunction of component or circuitry may directly or indirectly cause injury or threaten a life without expressed written approval of Rectron Inc. Customers using or selling Rectron components for use in such applications do so at their own risk and shall agree to fully indemnify Rectron Inc and its subsidiaries harmless against all claims, damages and expenditures.

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9